

Two-Cell Li-Ion and Li-Polymer Charge Management IC

PRODUCT SUMMARY

Charge management for two-cell Li-Ion or Li-Polymer battery packs Individual cell monitoring - avoids over-charging Pin-selectable charging current Cell-balancing control circuit - maximizes pack useful life

FEATURES

Optional external thermistor monitors the pack temperature Conditioning charging for reviving deeply discharged cells Timer function available to limit the charging time



DESCRIPTION

The SS4035G is a charging control IC designed for battery packs with two cells in series. When multiple cells in a battery pack are connected in series, the weakest cell determines the overall pack capacity. The SS4035G has a cell-balance control circuit to solve this problem, and monitors the voltage of each cell to ensure that no cell is over-charged. The pulse width modulation (PWM) output can be used as either a linear or switching charge-control circuit. Three digital input pins determine the charge current. All these features make the charging circuit design easy and flexible. The SS4035G continuously monitors each cell voltage, cell current and the battery temperature. Any unspecified condition will stop the charging to protect the battery cells. An external negativetemperature-coefficient thermistor is used as a sensor to monitor the battery pack temperature. To be safe, charging is suspended if the voltage of the temperature sense input pin is higher than Min Temp Threshold (VTmin) or lower than Max Temp Threshold (VTmax). When the battery

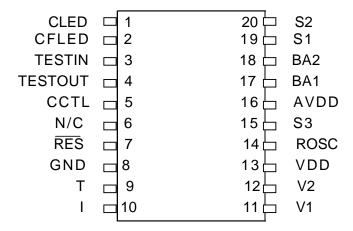
temperature is within the safe zone, the SS4035G charges the battery in three phases: pre-charging, constant-current, or constant-voltage. If the voltage of the temperature sense input pin is higher than *Low Temp Threshold* (Vtlow), or the battery voltage is less than 3.1V, the SS4035G pre-charges the battery with a low current.

After the precharging, the SS4035G applies a constant current to the battery. The value of this constant current is determined by the levels of pins S1, S2 and S3 during power up. When the battery voltage is above the threshold, the SS4035G begins constant-voltage charging until the battery is fully charged. The battery is fully charged when the current drops down to the termination threshold.

When the cell voltage is higher than the *Balancing Threshold* (Vbal), the cell balancing circuit is triggered if one cell voltage is higher than the other by more than 0.02V.



PIN CONFIGURATION



PIN DESCRIPTION

Pin Name	Pin No	I/O	Description		
CLED	1	0	Charge control LED		
CFLED	2	0	Charge Full control LED		
TESTIN	3	I	Test input		
TESTOUT	4	0	Test output		
CCTL	5	0	Charging Control, PWM output		
N/C	6	0	Not connected		
RES	7	I	Reset		
GND	8	G	Ground		
Т	9	Α	Temperature-sense voltage input		
I	10	Α	Current-sense voltage input		
V1	11	Α	Cell 1 voltage (low side)		
V2	12	Α	Cell 2 voltage (high side)		
V_{DD}	13	Р	Operating voltage input		
ROSC	14	I	Frequency control resistor		
S3	15	I	Selection no.3		
AVDD	16	Р	Operating voltage for analog circuit		
BA1	17	0	Balancing control for cell 1		
BA2	18	0	Balancing control for cell 2		
S1	19	I	Selection no.1		
S2	20	I	Selection no.2		



ABSOLUTE MAXIMUM RATINGS

DC Voltage -0.3V to +7.0V Storage Temperature -55°C to +125°C I/O Voltage (GND-0.3V) TO (V_{DD} +0.3V) Operating Temperature -40°C to +85°C

ELECTRICAL CHARACTERISTICS

 V_{DD} = 4.5V – 5.5V, GND = 0V, T_A = 25°C, f_{osc} = 8MHz, unless otherwise specified.

Parameter	Symbol	Min.	Тур.	Max	Unit	Condition
Operating Voltage	V_{DD}	4.5	5.0	5.5	V	
Operating Current	IOP	-	1.5	2	mA	No load, no ADC
Standby Current	I _{SB}	-	-	1	uA	No load, no ADC, no WDT, no LVR
Input Low Voltage	V _{IL1}	GND	-	0.2* V _{DD}	V	All I/O, except RES
Input Low Voltage	V _{IL2}	GND	-	0.15* V _{DD}	V	RES
Input High Voltage	V _{IH1}	0.8*V _{DD}	-	V_{DD}	V	All I/O, except RES
Input High Voltage	V_{IH2}	0.85*V _{DD}	-	V_{DD}	V	RES
Input Leakage Current	I _{IL}	-1	-	1	uA	Input pins, Vin=V _{DD} or GND
Output High Voltage	V _{OH}	V _{DD} -0.7	-	-	V	All I/O, I _{OH} =-10mA
Output Low Voltage	V _{OL}	-	-	GND +0.6	V	All I/O, I _{OL} =20mA
Analog Input	Ain	GND		V_{DD}	V	T, I, V1, V2

^{*} Stresses beyond those listed as "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied or intended. Exposure to the absolute maximum rating condition for an extended period may affect device reliability.



ELECTRICAL CHARACTERISTICS (continued)

 V_{DD} = 5V, GND = 0V, T_A = 25°C, f_{osc} = 8MHz, R_{sens}=100m Ω , unless otherwise specified.

Parameter	Symbol	Min.	Тур.	Max	Unit	Description	
Voltage Control							
Pre-charge Threshold	V_{low}	-	3.10	-	V		
CC/CV Threshold	V _{cv}	-	4.135	-	V	Switch to CV mode above this value	
Maximum Cell Voltage	V_{max}	-	4.235	-	V		
Balancing Threshold	V_{bal}	-	4.135	-	V		
Bad Battery Threshold	V_{bad}	-	0.5	-	V	Difference between Cell1 and Cell 2 voltage	
Temperature Sensing							
Min Temp Threshold	V _{tun}	-	4.31	_	V	Suspend charging if greater than this value	
Low Temp Threshold	VT _{low}	-	3.82	-	V	Precharge if greater than this value	
High Temp Threshold	VT _{high}	-	1.90	-	V	Decrease current if less than this value	
MaxTemp Threshold	VT _{over}	-	1.54	-	V	Suspend charging if less than this value	
Resume Temp Threshold	VT _{rsm}	-	2.10	-	V	After maximum temperature is reached, resume charging if greater than this value.	
Current Control							
Precharge Current	I _{pre}	-	300	-	mA		
Taper Current	I _{taper}	-	250	-	mA	Fully charged if the taper current is below this value.	
Time Control							
Maximum Charge Time	T _{chq}		340		Min		



FUNCTIONAL DESCRIPTION

A well-known Li-lon charge algorithm is used by the the SS4035G to control the charging. Figure 1 shows shows the typical charge profile. Figure 2 is the control flow chart. During the process of charging, the SS4035G continuously monitors each cell voltage, current and the battery temperature. Any unqualified condition will stop the charging to protect the battery cells.

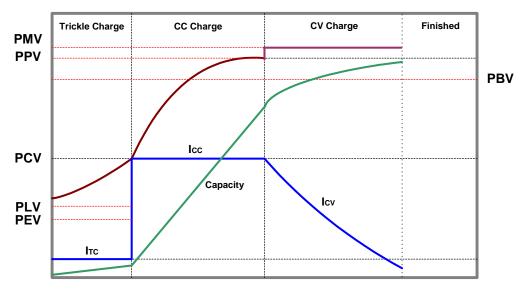


Figure 1. Typical Charge Profile



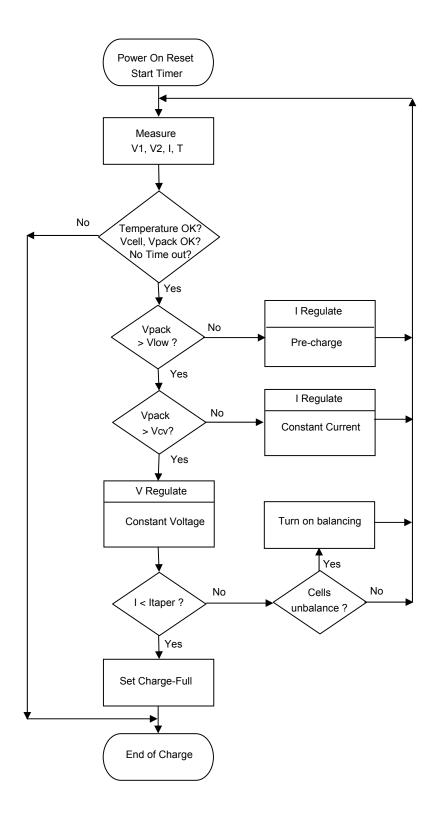


Figure 2. Control Flow Chart



CURRENT AND TEMPERATURE SENSING

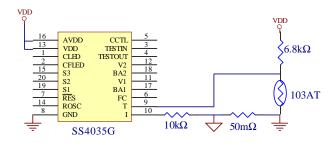


Figure 3. Current Sense and Temperature Sensor

Figure 3 shows the current sense and temperature detect circuit. The SS4035G monitors the charging current by sensing at pin I (10) the voltage drop across a small resistor, connected between VSS (battery negative) and GND (charger ground). The value of this resistor should be between $50m\Omega$ and $150m\Omega$. To detect the temperature, a negative temperature coefficient thermistor is used as a .

sensor. When a 103AT thermistor and a 6.8k resistor are used as recommended, the maximumum temperature, high temperature, resume temperature, low temperature and minimum temperature are 60°C, 50°C, 45°C, 5°C and 10°C respectively. The value of the resistor must be changed if a different thermistor is used. To disable temperature sensing, pin T (9) must be connected to V_{DD}.

CELL VOLTAGE DETECTION AND BALANCING CONTROL

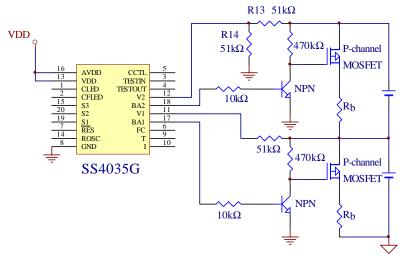


Figure 4. Voltage Sense and Balancing Control

Figure 4 shows the cell voltage detection and cell balancing circuit. The pack voltage is divided by two (by using equal value resistors, R13 and R14). This

guarantees that the input voltage on pin V2 (12) will not exceed VDD. When the cell voltage is above the "Balancing Threshold", balance control is activated.



If any cell voltage is greater than the other by 0.02V or more, the corresponding balance control output goes high. It then turns on the corresponding by-pass

transistor and sends a small current through resistor Rb. This slows down charging of the corresponding cell. The balance circuit turns off when the cells are balanced.

CHARGING CONTROL

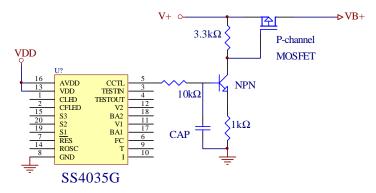


Figure 5. Charging Control

Figure 5 shows the linear charger mode for the SS4035G. The output of pin CCTL (5) is a pulse-width modulated (PWM) signal. This signal is translated to a DC voltage to control the P-channel

MOSFET which is operating in the active region.

This P-channel MOSFET must be chosen carefully to handle the required power dissipation.

DIGITAL CONTROLS

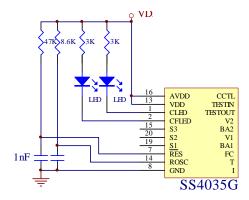


Figure 6. Current Selection and Logic Control

Figure 6 shows the connections for the digital pins for the SS4035G. Selection pins S1, S2 and S3

have internal pull-ups. Table 1 shows the options for selecting the required voltage for Isense.



Table 1. Current Selection Table

S3	S2	S1	I _{sense} Voltage
L	L	L	240 mV
L	L	Н	200 mV
L	Н	L	160 mV
L	Н	Н	120 mV
Н	L	L	40 mV
Н	L	Н	60 mV
Н	Н	L	80 mV
Н	Н	Н	100 mV

 $\overline{\text{RES}}$ (7) is the reset control. A low voltage on this pin will reset the device. Connect to V_{DD} if not used.

ROSC (14) is the frequency control input. For the SS4053G to work at 8MHz, this pin must be connected to V_{DD} through an $8.6k\Omega$ resistor.

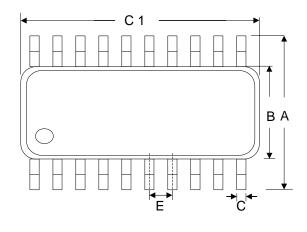
CLED (1) is the "charging" indication output. This pin goes low when the SS4035G is operating.

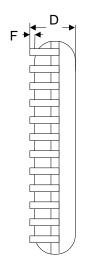
CFLED (2) is the "fully charged" indication output. This pin goes low when the battery is fully charged.

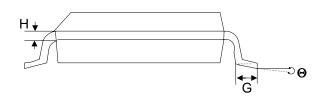


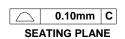
PHYSICAL DIMENSIONS (units: inches)

SO-20









Symbol	Dimensions in inches						
Symbol	min.	nom.	max.				
Α	0.394	-	0.419				
В	0.290	-	0.300				
С	0.014	-	0.020				
C1	0.480	-	0.520				
D	0.092	-	0.104				
Е	-	0.050	-				
F	0.004	-	-				
G	0.032	-	0.038				
Н	0.004	-	0.012				
Q	0 °	-	10 °				



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